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To the Director of the U.S. Patents and Trademark Office. Please record the attached documents or the new address(es) below.

113014 U.S. PTO
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3-16-06

1. Name of conveying party(ies)/Execution Date(s):

Sung-lyong Kim
Chang-ki Jeon

Execution Date(s) March 15, 2006

Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Fairchild Korea Semiconductor, Ltd.

Internal Address: _____

Street Address: : (420-711) 82-3 Dodang-Dong

Wonmi-gu

City: Bucheon Si

State: Gyeonggi-do

Country: Republic of Korea Zip: _____

Additional Name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application number(s) or patent number(s):

A. Patent Application No.(s)

This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: Thomas R. FitzGerald, Esq.

Internal Address: _____

2000 HSBC Plaza

Street Address: Hiscock & Barclay, LLP

2000 HSBC Plaza

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State: NY Zip: 14604-2404

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Email Address: tfitzgerald@hiscockbarclay.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 50-3010

Authorized User Name Thomas R. FitzGerald

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9. Signature :

Signature

Date

3/16/06

Thomas R. FitzGerald, Esq.

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents 3

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

FAIRCHILD KOREA SEMICONDUCTOR. LTD.

Assignment

As a below named inventor or joint inventor of an invention or improvement entitled:

**HIGH-VOLTAGE INTEGRATED CIRCUIT DEVICE INCLUDING
HIGH-VOLTAGE RESISTANT DIODE**

for which I have executed an application for Letters Patent of the United States of America, on an even date herewith; and

WHEREAS, FAIRCHILD KOREA SEMICONDUCTOR, LTD., a Large Entity, organized and existing under the laws of the Republic of Korea, having a principal place of business at (420-711) 82-3 Todang-Dong, Wonmi-District, Bucheon City, Kyonggi Province, Korea, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer and set over, unto said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, my entire right, title and interest in, to, and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuation applications thereof, and all Letters Patent of the United States of America which may be granted thereof and all reissues and extensions hereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention, all rights to register said invention in appropriate registries, and all Letters Patent which may be granted for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

And I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

And I hereby further covenant and agree that I will communicate to said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, any fact known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisions, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said invention in all countries,

**Attorney Docket:
3017471 (FS-24108-US)**

IN TESTIMONY WHEREOF, I authorize and affirm said assignments with the signature(s) set forth below on the indicated date(s).

Inventors:

Sunglyong Kim
Sung-lyong Kim

2006.3.15
Date

Chang Ki Jeon
Chang-Ki Jeon

2006.3.15
Date